STP200N3LL



N-channel 30 V, 2.15 m Ω typ., 120 A Power MOSFET in a TO-220 package

Datasheet - production data

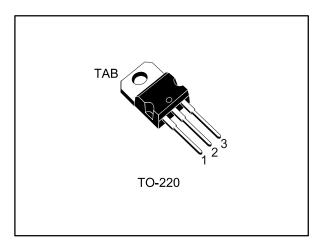
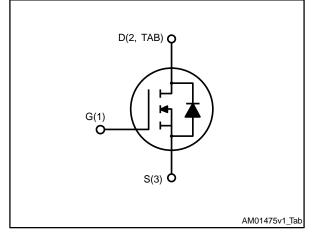


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	I _D	Ртот
STP200N3LL	30 V	2.4 mΩ	120 A	176.5 W

- Very low on-resistance
- Very low gate charge
- High avalanche ruggedness
- Low gate drive power loss

Applications

Switching applications

Description

This device is an N-channel Power MOSFET with very low $R_{\text{DS}(\text{on})}$ in all packages.

Table 1: Device summary

Order code	Marking	Package	Packing
STP200N3LL	200N3LL	TO-220	Tube

Contents STP200N3LL

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STP200N3LL Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	30	V
V_{GS}	Gate-source voltage	±20	V
I _D	Drain current (continuous) at T _{case} = 25 °C (silicon limited)	200	
I _D ⁽¹⁾	Drain current (continuous) at T _{case} = 25 °C	120	Α
I_D	Drain current (continuous) at T _{case} = 100 °C	120	
I _{DM} ⁽²⁾	Drain current (pulsed)	480	
Ртот	Total dissipation at T _{case} = 25 °C	176.5	W
E _{AS} ⁽³⁾	Single pulse avalanche energy	300	mJ
T _{stg}	Storage temperature range	EE to 17E	°C
Tj	Operating junction temperature range	–55 to 175	,

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	0.85	°C/W
R _{thj-amb}	hj-amb Thermal resistance junction-ambient		C/VV

⁽¹⁾ Current is limited by package.

⁽²⁾ Pulse width is limited by safe operating area.

 $^{^{(3)}}$ starting T_j = 25 °C, I_D = 68 A

Electrical characteristics STP200N3LL

2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Table 4: Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	30			V
	Zara gata valtaga drain	$V_{GS} = 0 \text{ V}, V_{DS} = 30 \text{ V}$			1	
IDSS	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 30 \text{ V},$ $T_{case} = 125 \text{ °C}^{(1)}$			10	μΑ
I _{GSS}	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1		2.5	V
D	Static drain-source on-	$V_{GS} = 10 \text{ V}, I_D = 60 \text{ A}$		2.15	2.4	m0
R _{DS(on)}	resistance	V _{GS} = 4.5 V, I _D = 60 A		2.5	3.1	mΩ

Notes:

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	5200	•	
Coss	Output capacitance	V _{DS} = 25 V, f = 1 MHz, V _{GS} = 0 V		640	-	pF
Crss	Reverse transfer capacitance			510	-	
Qg	Total gate charge	V _{DD} = 15 V, I _D = 120 A, V _{GS} = 4.5 V (see Figure 14: "Test circuit for gate charge behavior")		53	•	
Q_{gs}	Gate-source charge			13	-	nC
Q _{gd}	Gate-drain charge			27	-	
R _G	Intrinsic gate resistance	$f = 1$ MHz, $I_D = 0$ A, gate DC bias = 0 V, magnitude of alternative signal = 20 mV	-	1.1	-	Ω

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V_{DD} = 15 V, I_{D} = 60 A R _G = 4.7 Ω , V_{GS} = 10 V (see Figure 13: "Test circuit for resistive load switching times" and Figure 18: "Switching time waveform")	-	18	-	
tr	Rise time		-	183	-	
t _{d(off)}	Turn-off delay time		-	90	-	ns
t _f	Fall time		-	108	-	

 $[\]ensuremath{^{(1)}}\mbox{Defined}$ by design, not subject to production test.

2

Α

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{SD} ⁽¹⁾	Forward on voltage	V _{GS} = 0 V, I _{SD} = 60 A	-		1.1	V
t _{rr}	Reverse recovery time	I _{SD} = 120 A, di/dt = 100 A/µs,	1	35		ns
Qrr	Reverse recovery charge	V _{DD} = 24 V (see Figure 15: "Test circuit for inductive load switching	-	34		nC

and diode recovery times")

Table 7: Source-drain diode

Notes:

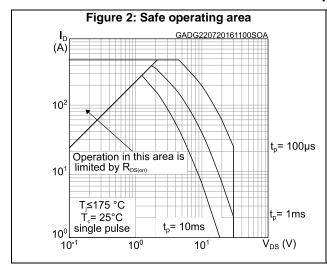
 I_{RRM}

current

Reverse recovery

 $^{^{(1)}}$ Pulse test: pulse duration = 300 $\mu s,$ duty cycle 1.5%.

2.1 Electrical characteristics (curves)



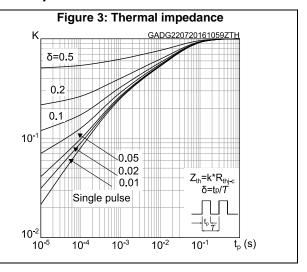
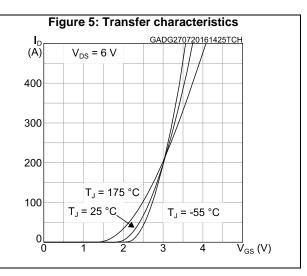
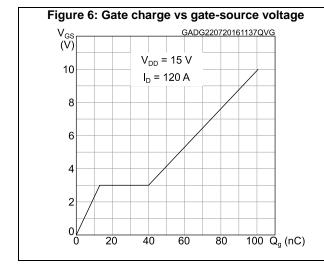
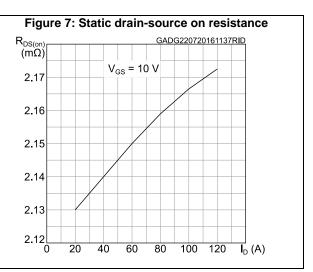


Figure 4: Output characteristics GADG220720161119OCH V_{GS} = 4 V, 3.8 V, 3.6 V (A) 200 180 3.2 V 160 3 V 140 2.8 V 120 2.6 V 100 80 60 2.4 V 40 20 2.2 V 6 $\overline{V}_{DS}(V)$







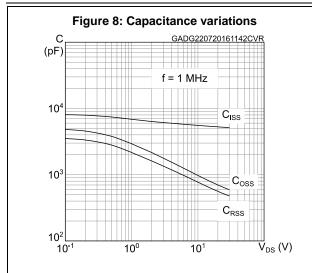


Figure 9: Normalized gate threshold voltage vs temperature

V_{GS(th)}
(norm.)

1.2

I_D = 250 μA

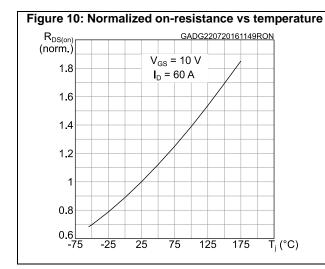
0.8

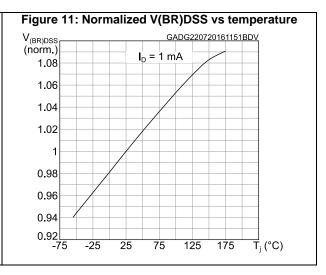
0.6

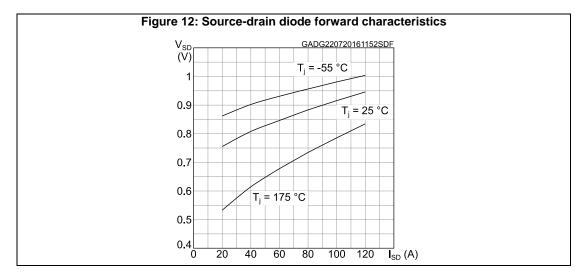
0.4

0.2

-75 -25 25 75 125 175 T_j (°C)







Test circuits STP200N3LL

3 Test circuits

Figure 13: Test circuit for resistive load switching times

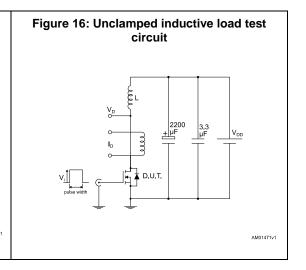
Figure 14: Test circuit for gate charge behavior

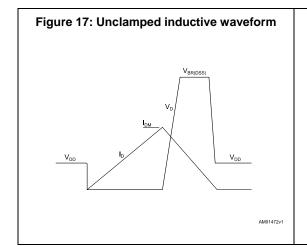
12 V 47 KΩ 100 N D.U.T.

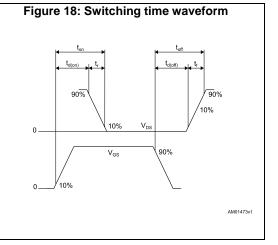
Vos 1 1 KΩ 100 N D.U.T.

AM01469v1

Figure 15: Test circuit for inductive load switching and diode recovery times







STP200N3LL Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.



4.1 TO-220 type A package information

Figure 19: TO-220 type A package outline

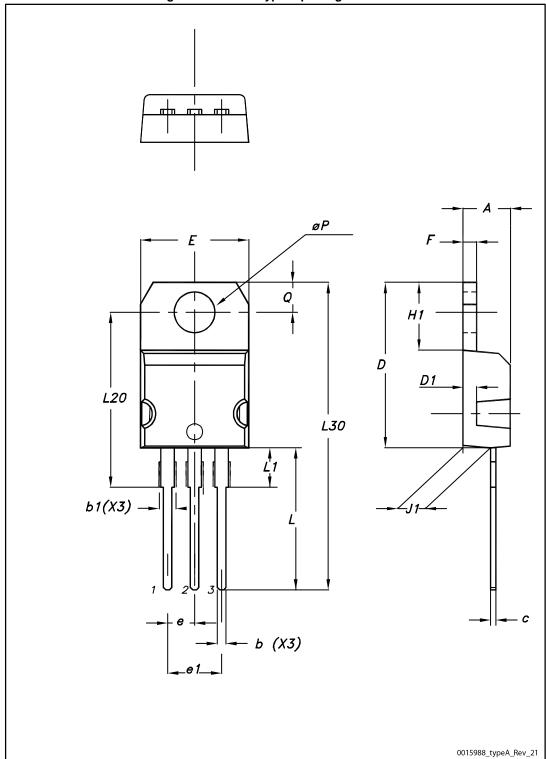


Table 8: TO-220 type A mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.40		4.60
b	0.61		0.88
b1	1.14		1.55
С	0.48		0.70
D	15.25		15.75
D1		1.27	
Е	10.00		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13.00		14.00
L1	3.50		3.93
L20		16.40	
L30		28.90	
øΡ	3.75		3.85
Q	2.65		2.95

Revision history STP200N3LL

5 Revision history

Table 9: Document revision history

Date	Revision	Changes
14-Dec-2015	1	First release.
27-Jul-2016	2	Document status promoted from preliminary to production data. Updated Section 2: "Electrical ratings" and Section 3: "Electrical characteristics". Added Section 3.1: "Electrical characteristics (curves)". Minor text changes.

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